

GLAST Large Area Telescope:

AntiCoincidence Detector (ACD) WBS 4.1.6

David J. Thompson, Subsystem Manager Thomas E. Johnson, ACD Manager NASA Goddard Space Flight Center djt@egret.gsfc.nasa.gov (301) 286-8168 tjohnson@mscmail.gsfc.nasa.gov (301) 286-1284



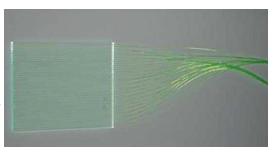
Outline - ACD

- □ Overview
- □ Results from January PDR/Baseline review
 - □ Findings and recommendations
 - ☐ Actions since the review
- □ Schedule and Budget
- □ Issues
- □ Summary

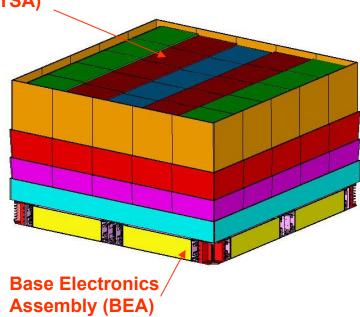


Anticoincidence Detector Overview

Prototype
ACD tile read
out with
Wavelength
Shifting Fiber



Tile Shell Assembly (TSA)



TILE SHELL ASSEMBLY

- 89 Plastic scintillator tiles
- Waveshifting fiber light collection (with clear fiber light guides for long runs)
- Two sets of fibers for each tile
- Tiles overlap in one dimension
- 8 scintillating fiber ribbons cover gaps in other dimension (not shown)
- Supported on self-standing composite shell
- Covered by thermal blanket + micrometeoroid shield (not shown)

BASE ELECTRONICS ASSEMBLY

- 194 photomultiplier tube sensors (2/tile)
- 12 electronics boards (two sets of 6), each handling up to 18 phototubes. High voltage power supply on each board.



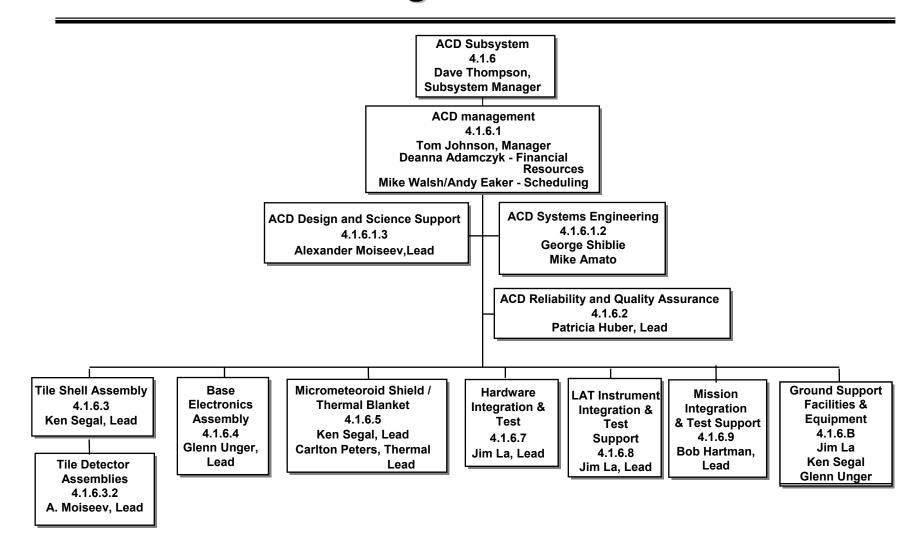
Level III Key Requirements Summary

Reference: LAT-SS-00016

Parameter	Requirement	Expected Performance	Verification Method
Detection of Charged	≥ 0.9997 average detection efficiency over entire	≥0.9997	Test and
Particles	area of ACD (less for bottom row of tiles)	≥0.99 (bottom tiles)	Analysis
Fast VETO signal	Logic signal 50-700 nsec after passage of charged particle	50-700 nsec	Test
PHA signal	For each phototube, pulse height measurement for each Trigger Acknowledge (TACK)		Test and
	Below 10 MIP, precision of <0.02 MIP or 5% (whichever larger)	< 0.02 MIP or 5%	Analysis
	Above 10 MIP, precision of < 1 MIP or 2% (whichever larger)	< 1 MIP or 2%	
False VETO rate - backsplash	< 20% false VETO's due to calorimeter backsplash at 300 GeV	< 20%	Analysis
False VETO rate - noise	< 1% gamma-ray rejection from false VETO's due to electrical noise	< 1%	Analysis
High Threshold (Heavy Nuclei) Detection	Detection of highly-ionized particles (C-N-O or heavier) for calorimeter calibration.	Yes	Test and Analysis
Size	Outside: 1796 x1796 x 1015 mm	1796 x1796 x 1015	Test
	Inside Grid: 1574 x 1574 x 204.7 mm	1574 x 1574 x 204.7	
	Inside TKR: 1515.5 x 1515.5 x 650 mm	1515.5 x 1515.5 x 650	
Mass	≤ 235 kg (228 + 7 allocated)	228	Test
Power	< 31 Watts (conditioned)	14	Test
Instrument Lifetime	Minimum 5 yrs	> 5 yr.	Analysis



ACD Organization Chart





ACD Team Space Flight Experience

Science

- Dave Thompson SAS-2, EGRET
- Bob Hartman SAS-2, EGRET
- Alex Moiseev GAMMA-1

Engineering

- Tom Johnson BBXRT, COBE, EUVE, SAMPEX, TRMM, HST
- George Shiblie FUSE, MAP
- Mike Amato Spartan 201, STIS (HST), Stereo COR1
- Ken Segal TRMM, HST, POES, EOS
- Glenn Unger MOLA, XTE, MAP
- Dave Sheppard BBXRT, XTE, TGRS, POEMS, GRS, Swift
- Satpal Singh EPACT and TGRS on WIND, Swift
- Art Ruitberg EGRET, COBE, POLAR, WIND, CASSINI, Triana
- Bob Baker HEAO, SMM, EGRET, BBXRT, XRS, XTE, Swift
- Jim La TDRS, POES, VCL/MBLA, Spartan, ROMPS, SLA, SEM
- Carlton Peters VCL, CATSAT, MAP, Triana



Summary of January Review

"The Committee found that there has been significant technical progress in terms of descoping and fully optimizing the ACD, while still meeting performance requirements. A schedule and a critical path analysis needs to be done for the ACD along with a revised bottoms-up estimate of the costs. The Committee concluded that the ACD subsystem is at the PDR level but was not ready for baselining at this time."

- ACD cost estimate and schedule have been revised and integrated with the LAT PMCS. Detailed Basis of Estimate, critical path analysis and contingency analysis have been prepared.
- Other (technical) recommendations from the January review are being addressed.



- 1. Finalize the design and generate the engineering drawings for the tile and fiber layout, including the lowest row of the ACD.
 - Designs for the 12 types of tile have been analyzed for thermal and vibration tolerances. Results are being used to generate engineering drawings.
 - Design for the lowest tile row is waiting for test results from two prototypes with different fiber layouts being made at Fermilab.
 - Preliminary drawings have been made for the routing of the fibers from the tiles to the phototubes. The routing is being checked using a mock-up of the ACD (about 80% complete). Final routing and drawings depend on the final tile designs.

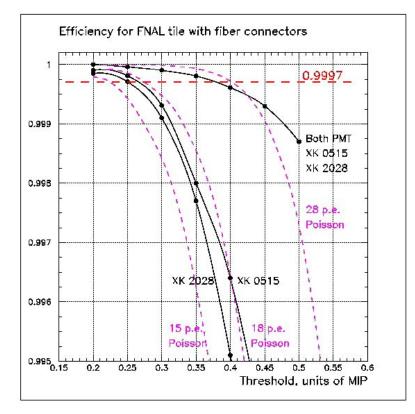


2. Perform light yield tests and muon detection efficiency measurement of the final optical system (scintillator tiles; and fiber ribbons, connector, clear fibers, and photomultiplier tubes).

Complete – results are similar to those shown in January: with two phototubes, 0.9997 efficiency is met; with one phototube, efficiency is ~ 0.999

Light output of Fermilab tiles is good.
Light losses in the optical connector
and clear fibers are higher than
expected. Further tests will be done to
identify and improve the light loss.

LAT-TD-00843-D1, Design Qualification Tests for ACD TDA and Phototubes



Performance of a full end-to-end TDA



3. Demonstrate that electronic noise of the system is low enough not to affect the muon rejection efficiency and efficiency for gammas by more than one percent.

Bench tests of the first analog ASIC show no noise problem. Tests on a full electronics card are planned for October.

The ACD electronics noise is required to be < 0.2 X threshold. The early calculations show that the noise at the lowest threshold setting of 0.1 MIP is approximately 50% lower than the requirement.

The ACD team along with the LAT Electronics Systems Engineers have designed a grounding and shielding scheme to keep noise to a minimum.



4. Complete full mockup of ACD, including clear fiber layout to photomultiplier tubes.

The mockup has been built and many (~80%) of the tile and fiber routing placements have been completed.



Details of mock-up.

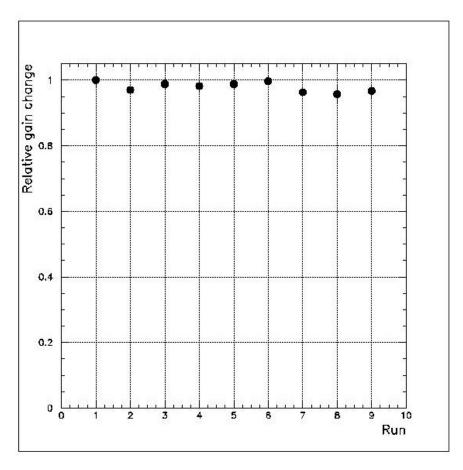


Full-scale mock-up of ACD being used for tile placement and fiber routing from tiles to phototubes. Two bottom tile rows have been included.



- 5. Perform thermal cycle of fully assembled tiles and ribbons. Verify that no damage to tile/fiber assemblies takes place and light yield is not decreased.
 - Thermal cycle was -65 C to +45 C.
 - Performance was measured using a muon telescope for Minimum Ionizing Particles.
 - After 340 cycles, the loss of performance was less than 5%.

LAT-TD-00858-D1, ACD TDA Thermal Cycling Test



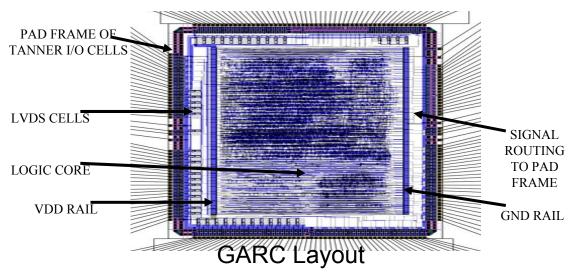
Light yield of Tile/fiber assembly during thermal cycling.

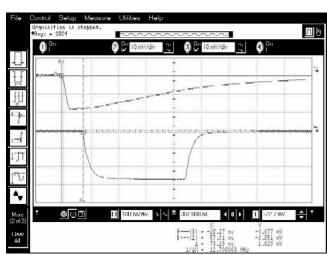


- 6. Prepare a plan for Quality Control (tile response uniformity and broken fibers) and initial calibration (ADC/minimum ionizing particle) of the ACD system prior to the delivery to the Stanford Linear Accelerator Center.
 - Quality Control is covered by the general ACD Quality Plan (ACD-QA-8001). Specific guidelines for handling of the TDAs will be written as an addendum to this document.
 - The methods for determining tile response uniformity and detecting broken fibers are documented in "Light Collection/Optical Performance Tests" (LAT-TD-00438-D2). Performance is measured using a muon telescope for Minimum Ionizing Particles.
 - A plan for calibrating the ACD using a muon telescope for mapping reference efficiency and then using internal triggers for PHA distributions is described in "ACD Gain Calibration Test with Cosmic Ray Muons" (LAT-TD-00844-D1). This approach was tested using the balloon flight ACD.



- 7. Additional time should be added to the ASIC production schedule to provide some schedule margin.
 - The current LAT extended schedule incorporates an additional month for ASIC development and additional testing time.
 - The GSFC Program management approved qualification and screening process for the ASICs is now shorter than the original one.
 - The scheduled ACD completion is now 15 weeks before the LAT integration need date.





GAFE Veto Generation – 1 MIP



- 8. Complete the bottoms-up Work Breakdown Structure in the Primavera framework.
 - The WBS has been completed and has 10 major elements:
 - 4.1.6.1 Project Management/Systems Engineering/Science
 - 4.1.6.2 Safety and Mission Assurance
 - 4.1.6.3 Tile Shell Assembly
 - 4.1.6.4 Base Electronics Assembly
 - 4.1.6.5 Micrometeoroid Shield/Thermal Blanket Assembly
 - 4.1.6.6 Mechanical Qualification and Calibration Unit
 - 4.1.6.7 Integration and Test
 - 4.1.6.8 LAT Integration and Test Support
 - 4.1.6.9 Mission Integration and Test Support
 - 4.1.6.B Ground Support Equipment and Facilities



9. Perform the critical path schedule analysis for the entire subsystem. Provide detailed documentation (at the lowest level of WBS) for the Basis of Estimate of the costs, in particular the onproject and off-project labor costs.

One critical path has been identified (details in a later slide):

- ASIC development and testing. Three iterations of the ASICs are scheduled. Turnaround time from submittal to delivery is typically at least 12 weeks. Adding testing time means that one iteration can take at least four months. Shortened time for the screening testing helps. Scheduled ACD completion is 15 weeks before the LAT integration need date.
- Photomultiplier tube delivery had been a critical path. The 6month schedule extension alleviated that pressure.

A detailed Basis of Estimate is available. Summaries in later slides.



10. Perform the contingency analysis of the subsystem. In particular, assess contingency for the off-project labor tasks.

A detailed contingency analysis, including all aspects of the ACD, has been carried out and incorporated into the PMCS. Some examples of contingency are shown in later slides.

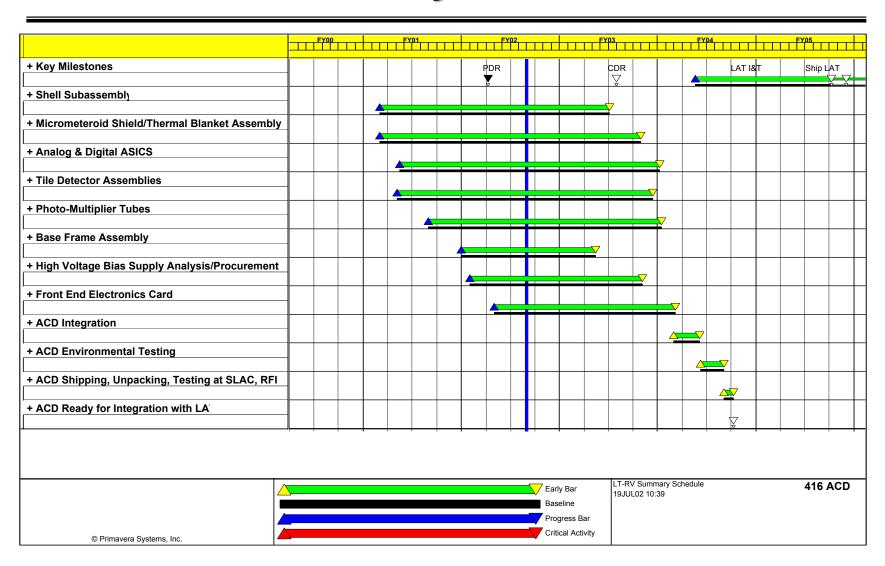


- 11. Due to lack of a verifiable Work Breakdown Structure (cost estimate) for the ACD, the subsystem is not ready to be baselined at the present time. Consider the following streamlining steps:
 - Separate materials and services from the labor tasks at lowest WBS level
 - Identify all the off-project labor costs at the lowest WBS level
 - Use the actual, fully loaded costs for technicians, specialists, engineers, etc., in all WBS labor estimates
- The PMCS contains most of this detailed information. Each resource is identified. Summaries are presented in later slides.
- Because the Goddard tax system is based on estimates rather than actuals, the labor costs are not fully loaded.
- 12. Conduct a Subsystem Baseline Review as soon as the work on the subsystem Work Breakdown Structure is completed.

This is that review.



Summary Schedule





Key Level 3 Milestones

Activity	AV: Early	Float	Baseline	F	Y02		FY	′03			FY	′04			FY	05	
Description	Finish		Finish			Q1			Q4	Q1			Q4	Q1			Q4
4.1.6 ACD																	
Test/Screening Board w/ASIC for EM1 -ACD to Elec	09/20/02	0	09/20/02		¥												
High Voltage Power Supply (Bd & Prts)-ACD toElec	08/26/02	58	11/15/02		Δ	¥											
Doc defining Backsplash Test Model (ACD to I&T)	01/03/03	0	01/03/03			Σ	X										
(11) FREE Bds & ASICS, (1) Fully Tested Bd - EM2	03/04/03	4	03/10/03				¥										
ACD Calibration Test Unit at SLAC, Tested & RFI	10/31/03	66	02/17/04							Δ	¥						
ACD Test Scripts (from ACD to I&T)	03/05/04	104	08/02/04										¥				
ACD Flight Unit at SLAC, Tested/Inspected & RFI	07/09/04	75	10/25/04											\bigvee			

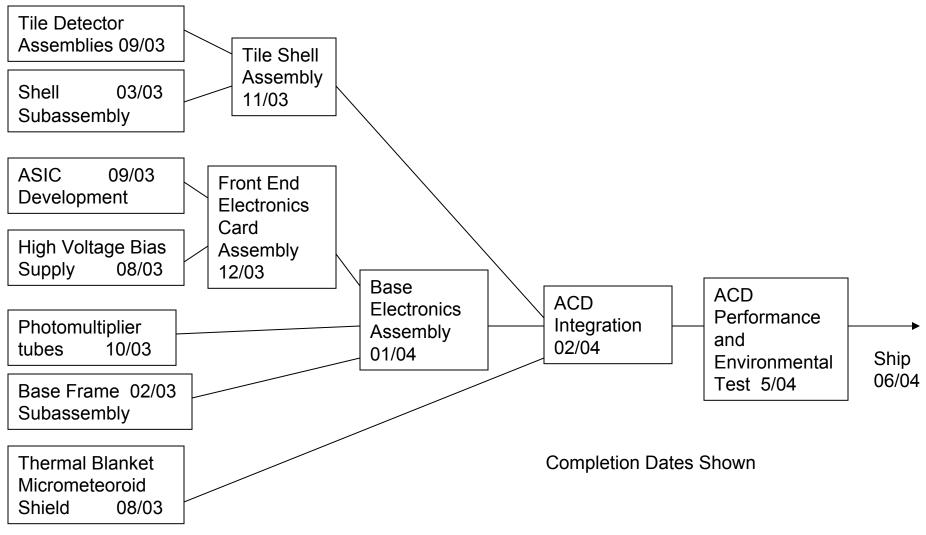
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 GLAST LAT PROJECT
 LAT3
 Sheet 3

 Data Date
 06/01/02
 Key Milestones
 LT-D4: Key Milestones

 © Primavera Systems, Inc.
 FL-D4: Key Milestones



ACD Work Flow Overview





ACD Critical Path – Flight Analog ASIC

Activity	Dates
Second generation analog ASIC testing and	9/12/02 – 2/28/03
flight analog ASIC design	
Fabricate Flight Analog ASIC	3/3/03 - 5/27/03
Slice Die for Flight Analog ASIC	5/28/03 - 6/25/03
Package and Inspect Flight Analog ASIC	6/26/03 - 8/8/03
Testing Services for Flight Analog ASIC	8/11/03 - 10/8/03
Populate FREE Boards with Flt Analog ASIC	10/9/03 - 10/15/03
Populate FREE Boards with Flt, ADC, & DAC	10/16/03 - 10/29/03
Populate FREE Boards with Flt Digital ASIC	10/30/03 - 11/5/03
Populate FREE Boards with Flt PMT's &	11/6/03 - 11/19/03
Inspect	
Flight FREE Board Validation Tests	11/20/03 - 12/4/03
Install & Test FREE Boards, HVBS, & PMT's	12/5/03 - 1/12/04
Install & Test TDA	1/13/04 - 1/29/04
Complete ACD Integration	1/30/04 - 2/5/04
Performance Efficiency Verification Test	2/6/04 - 3/5/04
ACD Environmental Tests	3/8/04 - 6/2/04
Shipping Prep	6/3/04 - 6/4/04
Ship to SLAC, Test, & RFI	6/7/04 - 7/9/04



Goddard Costing

Labor

- Civil Service We do not pay salary for Civil Servants, but we do pay Multi-Program Support (MPS, see below)
- Contractor We pay contractor costs plus MPS

Taxes

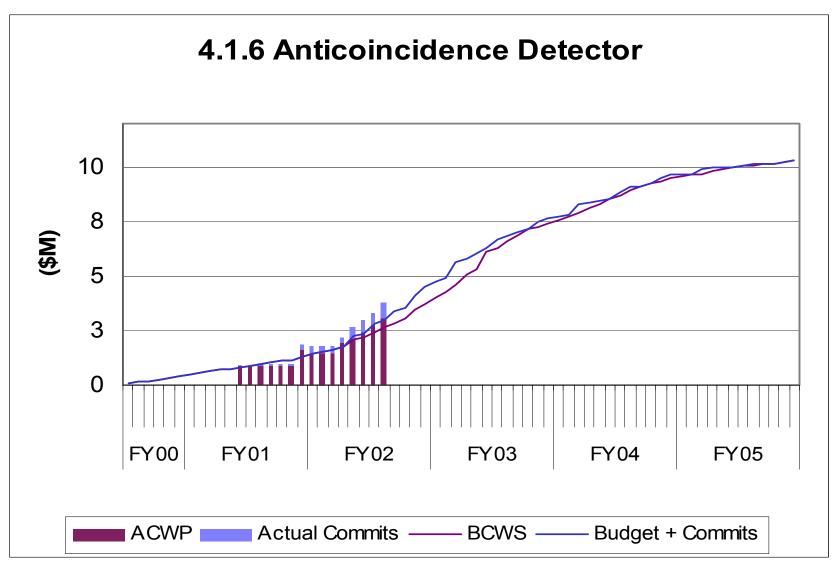
- MPS This tax pays for Goddard overhead and is charged for flight projects at a flat rate of \$35K per on-site FTE, based on the estimated manpower usage.
- Lab Tax This tax pays for local services such as computer systems support, publications, and office supplies. It is charged at a rate of 4% of the total cost of the project.

Procurements

- Ordinary Purchase Requests are issued. Large items are required to be competed unless justified as sole source.
- Shop Fabrication purchases made through the Goddard shops may be done in-house or sent to contractors. Costs are estimated by Goddard staff, but they get bids to determine actual cost.

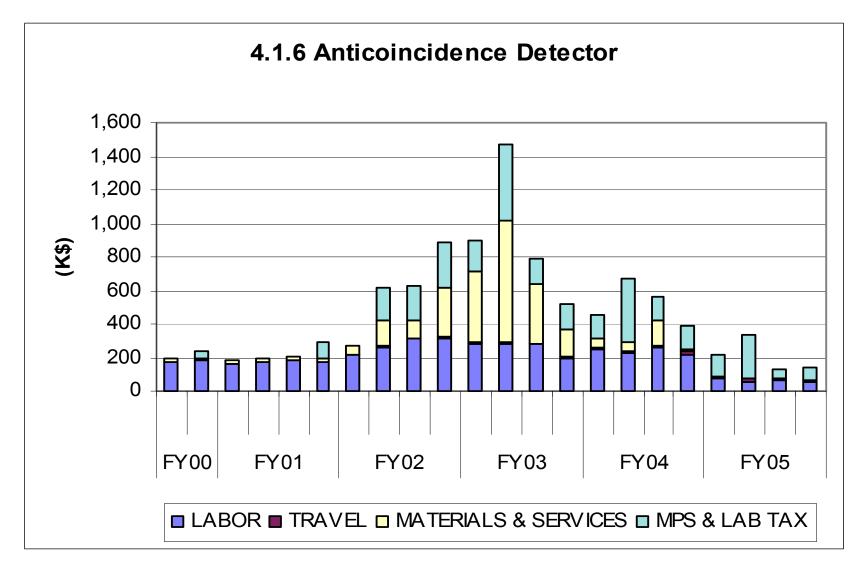


Cost & Commitments



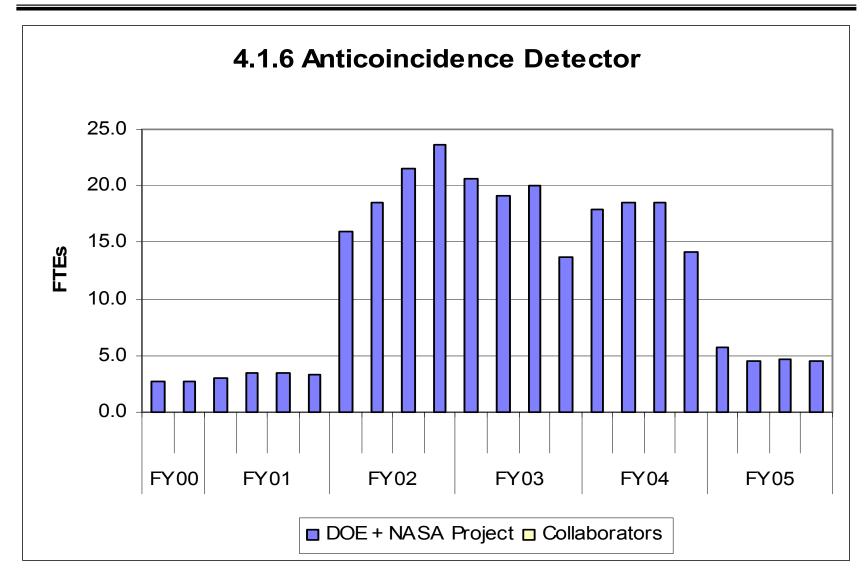


Cost Profile





Manpower Plan





Cost/Manpower Overview by Fiscal Year

FY	Cost (\$M) + Commit	FTE	Activities
2000	0.4	3.0	Planning, test
2001	0.9	6.5	Planning, test, design
2002	3.2	19.9	Complete design, start fabrication
2003	3.1	18.4	Fabrication, assembly, test
2004	2.0	17.3	Integration, test, delivery, LAT support
2005	0.7	4.9	LAT support
TOTAL	10.3	70.0	

FTE
≡ 1976 hours



Cost/Manpower Overview by Task

WBS Element	Total Cost	M&S	Labor	Travel	Taxes	Contract FTE	CS FTE
4.1.6.1							
Management/Systems							
Eng/Science Support	4,827,823	125,504	1,594,222	56,902	3,051,195	12.6	19.2
4.1.6.2 Safety & Mission							
Assurance	576,428	0	576,428	0		5	0
4.1.6.3 Tile Shell							
Assembly	1,620,559	1,022,724	578,833	19,001		3.7	2.2
4.1.6.4 Base Electronics							
Assembly	1,784,995	898,520	879,994	6,481		6.3	3.6
4.1.6.5 Micrometeoroid							
Shield/Thermal Blanket	150,096	121,051	29,045	0		0.3	0.3
4.1.6.6 Mechanical Qual		400 400		0.000			
& Calibration Unit	202,434	102,183	94,243	6,008		0.8	0.4
4.1.6.7 Integration & Test	627,978	182,005	420,973	25,000		3.8	7.8
4.1.6.8 LAT Integration &							
Test Support	35,630	0	0	35,630		0	0
4.1.6.9 Mission							
Integration & Test	1,380	1,162	217	0		0	0
4.1.6.B GSE	453,094	229,005	224,089	0		2.1	1.9
	,	, -	, -				
Total	10,280,416	2,682,154	4,398,044	149,023	3,051,195	34.6	35.4

Civil Service personnel salaries are paid by Goddard, not the LAT.

Taxes: Goddard overhead, charged on the basis of on-site FTE and total cost.

Name Document: LAT-PR-#####-##



Manpower Skill Mix by Fiscal Year

RESOURCE	2002	2003	2004	2005
GSFC CS Clerical	0.04	0.04	0.02	0
GSFC CS Engineer	6.5	5.0	5.3	1.0
GSFC CS Prof Admin	1.0	1.0	0.9	0.6
GSFC CS R&D Supervisory	0.6	0.7	0.7	0.4
GSFC CS Scientist	0.9	0.9	0.9	0.9
GSFC CS Technician	1.0	1.2	1.0	0.1
GSFC Contractor I&T Engineer	0.1	0.1	0.0	0.0
GSFC Quality Assurance	1.6	1.9	1.5	0.0
GSFC Contractor On-Site Admin	0.6	0.6	0.5	0.5
GSFC Contractor On-Site Clerical	0.5	0.5	0.5	0.1
GSFC Contractor Sr Engineer	4.4	1.9	2.1	0.3
GSFC Contractor Jr Engineer	0.8	1.6	1.3	0.1
GSFC Contractor Sr Technician	0.9	2.1	1.7	0.1
GSFC Sr Scientist	0.9	0.9	0.9	0.9
TOTAL	19.8	18.4	17.3	5.0



ACD - Largest Procurements

Item	Cost	Supplier	Basis of Estimate	Contingency
Flight shell (composite)	\$360,000	Composite	3 vendor quotes	28%
		vendor		
Flight phototubes	330,000	Hamamatsu	Vendor quote	10%
Flight tile detector assemblies	195,000	Fermilab	Quote	32%
Micrometeoroid shield	100,000	JSC	Fixed quote	21%
design/test				
Clear fiber bundles/connectors	97,000	GSFC	Eng. Estimate, prev. exper.	38%
Digital ASIC (2 runs)	88,300	MOSIS	Catalog price	10%
Thermal Vac Cables	62,166	GSFC	Previous experience	32%
Tile detector tiedown hardware	61,500	Composite	Vendor quote	32%
		vendor		
Flt. Spare tile detector assmbl.	61,000	Fermilab	Quote	32%
Test shell fab and assembly	42,000	Composite	Eng. Estimate, prev. exper.	24%
		vendor		
HV bias supplies fabrication	40,000	SAIC	Vendor quote	38%
Test tile detector assemblies	30,000	Fermilab	Quote	32%
COTS phototubes	30,000	Hamamatsu	Fixed price, catalog	10%
Base frame handling dolly fab	30,000	GSFC	Mech. Branch estimate	32%
Tile shell handling dolly fab	25,999	GSFC	Mech. Branch estimate	32%
Shipping container fab	25,999	GSFC	Mech. Branch estimate	32%
Tile detector development	25,000	Fermilab	Quote	32%
Fiber ribbon flight unit fab	22,000	Wash. U.	Vendor quote	32%
Turnover/assembly dolly fab	21,999	GSFC	Mech. Branch estimate	32%



ACD – Costs of Major Tests

Item	Cost	Supplier	Basis of Estimate	Contingency
ACD Thermal Bal/Vac (24/7)	\$193,460	GSFC	Test Branch estimate, LOE	28%
ASIC Testing Services	80,000	GSFC	Parts branch estimate	31%
Mech. Subsys. Thermal tests	35,899	GSFC	Test Branch estimate, LOE	32%
Mech. Subsys. Vibe tests	32,817	GSFC	Test Branch estimate, LOE	32%
ACD vibe test	43,055	GSFC	Test Branch estimate, LOE	28%
EMI/EMC test	36,576	GSFC	Test Branch estimate, LOE	28%
Test unit tile shell vibe test	19,505	GSFC	Test Branch estimate, LOE	28%
ACD acoustics test	27,956	GSFC	Test Branch estimate, LOE	28%
Mech. Subsys. acoustics test	17,413	GSFC	Test Branch estimate, LOE	28%
Mech. Subsys. Mass prop. test	14,563	GSFC	Test Branch estimate, LOE	28%
Test unit base frame vibe test	14,376	GSFC	Test Branch estimate, LOE	28%
ACD Mass prop. test	19,098	GSFC	Test Branch estimate, LOE	28%



Some ACD Risks - Not Likely, But Possible

		Cost	Schedul	Technical Impact without		
Risk Description	Probability	Impact	e Impact	mitigation/ Description	Mitigation Plan/Results	Contigency Plan
-				2 - lose effective area,	-	
D				lower background	Three foundry runs,	
Design flaw in flight ASIC				rejection, no diffuse	comprehensive test	Replace with newly
	Medium	Medium	High	measurement	•	designed ASICs
					F 9, F	
Tile Assy. (Tiles, ribbons & PMT) fail				2R - Lose ability to	Early testing, detailed	
efficiency test in ACD Qualification	Medium	Medium	Medium	measure difuse radiation	3	Thicker tiles
				2 - if systematic, lose		Analyze and redesign
				effective area, lower		the PMT assembly
				background rejection, no		process for systematic
Corona in Thermal Vac around HV				diffuse measurement	Early testing and	failure. Re-pot PMT
				3 - Lower efficiency if	qualification of	assembly for
	Low	Medium	High	workmanship failure	subassembly	workmanship failure.
	2011	Widaiaiii	111911	Workmaneriip landre	PMT qualification program	Werking lander.
PMT Fails in test	Low	Medium	High	3 - Lower efficiency	and burn-in	Replace with spares
	2011	Widaiaiii	111911	c Lower dimerency	Early testing and	rtopiaco maroparco
Light Leak in the detector system channel				2R - Lose ability to	qualification of	
3 · · · · · · · · · · · · · · · · · · ·	Medium	Low	Medium	measure difuse radiation	subassembly	
Mechanical interference problem found				1 - cannot fly without ACD	Design checks and early	
during assembly	Low	Low	Medium	or something above	Fit checks	Modify BEA
				_	Subassembly test, careful	-
Waveshifting fibers break in					tiedown. If you had a	
environmental testing					failure in a later	
environmental testing					environmental test, the cost	
	Low	Low	High	3 - Lower efficiency	will increase.	cable tie-downs
		Low/Me			Conservative design,	
Tile comes loose in acoustics		d			analysis, mechanical	Analyze failure, repair
	Low	<100k	High	3 - Lower efficiency	qualification program	or redesign
EMI/EMC produces noisey signals					Careful design, early	
Livit produces noisey signals	Low	Low	Medium	3 - Lower efficiency	subassembly tests	
HVBS fails in test				2R - Lose ability to	HVBS qualification	
TV BS lails in lest	Low	Medium	High	measure difuse radiation	program and burn-in	Replace with spares
Chrystynal Failure / La Jamana at failure			-		Conservative design,	•
Structural Failure (I.e. lamenant failure,					analysis, mech. qual	Analyze failure, repair
bond failure, etc)	Low	Low/Med	Medium	3 - Lower efficiency	program	or redesign
Other BEA electronics subassembly				•	Early testing and	_
failure	Low	Low	High	2R	qualification of	Replace with spares
QA finds problem in part (ie GIDEP alert)	Low	Low/Med	Medium	3 - Lower efficiency	None	Replace w/ different
Civil Servant test conductors pulled off for					High visibility with GSFC	Hire and Train test
another project	Medium	Medium	Medium	4 - only schedule impact	management	conductors



Summary

- The ACD continues to make technical progress. Most of the technical recommendations from the January review have been resolved. Additional test planning is still needed.
- The ACD has developed a coherent, verifiable cost and schedule plan. Basis of Estimate, critical path analysis and contingency have been clarified.
- The schedule has three months of float at the end.
- The ACD faces no unusual risks. The risks are those experienced by any space flight instrument.



Backup material



Second Quarter FY03 Cost Spike

Costs show a peak in FY03 Q 2 – total of	\$1.5 M
Manpower is about the same as other Q	0.3 M
Extra MPS and lab taxes are costed this Q	0.5 M
Several major hardware purchases this Q	
•Flight TDAs	0.2 M
•Flight fiber cables	0.1 M
PMT housing assembly	0.1 M
•Mechanical GSE	0.09 M
•Thermal Vac cables	0.085 M



Level 3 Key Milestones

ACD Subsystem Requirements Review	03/20/01
Anticoincidence Detector PDR	07/25/01
Prototype Electronics Module (Elec to ACD)	04/15/02
EGSE Workstation / Software #1 (I&T to ACD)	04/15/02
Test/Screening Board for EM1 - ACD to Elec	09/20/02
Anticoincidence Detector CDR	10/07/02
High Voltage Power Supply (Bd & Prts)-ACD to Elec	11/15/02
Doc. Defining Calibration Model - ACD to I&T	01/03/03
(11) FREE Bds & ASICS, (1) Fully Tested Bd - EM2	03/10/03
Flight Grid Ready for ACD Fit Test-(Mech to ACD)	05/08/03
ACD Calibration Test Unit at SLAC, Tested & RFI	02/17/04
ACD Test Scripts (from ACD to I&T)	08/02/04
ACD Flight Unit at SLAC, Tested/Inspected & RFI	10/25/04



Contractor FTE's - Details (1)

			EV	EV	EV	EV	EV	EV
ACT ID	DESC	TOTAL	2000	2001	2002	2003	2004	2005
446446	D DDO IECT MANACEMENT/CUDEY	CTEM ENG						,
4.1.6.1 ACI	D PROJECT MANAGEMENT/SUBSY	SIEW ENG.						
DGL\$	GSFC Labor (fully loaded)	1.07	0.36	0.70				
DGLHA	GSFC On-Site Administrative	2.11			0.54	0.54	0.54	0.49
DGLHC	GSFC On-Site Clerical	1.42			0.45	0.45	0.45	0.07
DGLHE	GSFC H Engineer	2.70			0.90	0.90	0.68	0.23
DGLHJ	GSFC H Jr Engineer	1.71			0.47	0.90	0.34	0.00
DGLUS	GSFC U Sr. Scientist	3.61 12.61	0.36	0.70	0.90 3.26	0.90	0.90 2.91	0.90
TOTAL	61	12.61	0.36	0.70	3.26	3.69	2.91	1.68
4.1.6.2 SAF	FETY & MISSION ASSURANCE							
DGL\$	GSFC Labor (fully loaded)	0.36	0.12	0.23				
DGLEQ	GSFC Quality Assurance	4.70			1.58	1.69	1.43	
TOTAL	62	5.06	0.12	0.23	1.58	1.69	1.43	
4.1.6.3 TILI	E SHELL ASSEMBLY (TSA)							
DOI #	00501-b (falls land-d)	4.50	0.50	4.00				
DGL\$ DGLEI	GSFC Labor (fully loaded) GSFC I&T Engineer	1.56 0.09	0.53	1.03	0.07	0.02		
DGLEI	GSFC (&) Engineer GSFC Quality Assurance	0.09			0.07	0.02		
DGLLQ	GSFC On-Site Administrative	0.06			0.04	0.07		
DGLHE	GSFC H Engineer	1.27		0.00	1.25	0.02		
DGLHJ	GSFC H Jr Engineer	0.17		0.00	0.14	0.03		
DGLHT	GSFC H Sr Technician	0.47			0.30	0.17		
TOTAL	63	3.73	0.53	1.03	1.84	0.33		
4.1.6.4 BAS	SE ELECTRONICS ASSEMBLY (BEA	A)						
DOI 4		,	0.07	4.00				
DGL\$ DGLEQ	GSFC Labor (fully loaded) GSFC Quality Assurance	1.96 0.16	0.67	1.30	0.00	0.14	0.02	
DGLEQ	GSFC Quality Assurance GSFC H Engineer	1.98			1.70	0.14	0.02	
DGLHL	GSFC H Engineer	0.06			0.06	0.20		
DGLHT	GSFC H Sr Technician	2.15			0.00	1.37	0.49	
TOTAL	64	6.31	0.67	1.30	2.04	1.79	0.52	
4 1 6 5 MIC	ROMETEOROID SHIELD/THERMAL	DI ANKET						
7. 1.0.5 IVIIC	COMIL LEGICOLD SHIELD/ I HERMAL	. DEANNET						
DGLEQ	GSFC Quality Assurance	0.00				0.00		
DGLHA	GSFC On-Site Administrative	0.03			0.01	0.02		
DGLHE	GSFC H Engineer	0.10			0.01	0.08		
DGLHJ	GSFC H Jr Engineer	0.13			0.02	0.12		
TOTAL	65	0.26			0.04	0.22		



Contractor FTE's - Details (2)

ACT ID	DESC	TOTAL	FY 2000	FY 2001	FY 2002	FY 2003	FY 2004	FY 2005
4.1.6.6 ACD	MECHANICAL QUALIFICATION &	CALIBRAT						
DGLEI	GSFC I&T Engineer	0.03			0.02	0.01		
DGLEQ	GSFC Quality Assurance	0.02				0.02		
DGLHE	GSFC H Engineer	0.30			0.03	0.28		
DGLHJ	GSFC H Jr Engineer	0.46			0.10	0.36		
TOTAL	66	0.81			0.15	0.66		
4.1.6.7 ACD	INTEGRATION & TEST							
DGLHE	GSFC H Engineer	1.48				0.04	1.38	0.06
DGLHJ	GSFC H Jr Engineer	0.95					0.89	0.06
DGLHT	GSFC H Sr Technician	1.33				0.06	1.21	0.06
TOTAL	67	3.76				0.09	3.48	0.19
4.1.6.9 MIS	SION INTEGRATION & TEST SUPP	ORT						
DGLHE	GSFC H Engineer	0.00						0.00
TOTAL	69	0.00						0.00
4.1.6.B GR	OUND SUPPORT FACILITIES & EQ	UIPMENT						
DGLEI	GSFC I&T Engineer	0.08				0.08	0.00	
DGLEQ	GSFC Quality Assurance	0.01				0.01	0.00	
DGLHA	GSFC On-Site Administrative	0.01			0.01			
DGLHE	GSFC H Engineer	0.85		0.00	0.53	0.28	0.03	
DGLHJ	GSFC H Jr Engineer GSFC H Sr Technician	0.22			0.00	0.15	0.06	
DGLHT TOTAL	6B	0.90 2.07		0.00	0.35 0.89	0.55 1.07	0.10	
IJIAL				0.00	0.03	1.07	0.10	
	REPORT TOTAL	34.62	1.68	3.27	9.81	9.55	8.44	1.87



Civil Service FTE's – Details (1)

_			FY	FY	Fi	FY	FY	FY
ACT ID	DESC	TOTAL	2000	2001	2002	2003	2004	2005
4.1.6.1 ACD	PROJECT MANAGEMENT/SUBS	SYSTEM ENG						
DOI 00	CCEC CC Clarical	0.44			0.04	0.04	0.00	
DGLCC DGLCE	GSFC CS Clerical	0.11 7.19	0.69	1.35	0.04 1.51	0.04 1.53	0.02 1.20	0.90
DGLCE	GSFC CS Engineer GSFC CS Prof Admin	4.59	0.69	0.72	0.95	1.04	0.89	0.90
DGLCF	GLRD CS R&D Supervisory	3.02	0.05	0.72	0.93	0.72	0.89	0.03
DGLCK	GSFC CS Scientist	4.29	0.03	0.45	0.03	0.72	0.72	0.90
TOTAL	61	19.19	1.34	3.06	4.03	4.23	3.73	2.80
IOIAL	01	13.13	1.04	5.00	4.00	7.20	0.70	2.00
4.1.6.3 TILE	SHELL ASSEMBLY (TSA)							
DGLCE	GSFC CS Engineer	1.62		0.00	1.34	0.28		
DGLCP	GSFC CS Prof Admin	0.02		0.00	0.01	0.01		
DGLCT	GSFC CS Technician	0.54		0.00	0.33	0.21		
TOTAL	63	2.18		0.00	1.68	0.50		
4.1.6.4 BAS	SE ELECTRONICS ASSEMBLY (BI	Ξ A)						
DGLCE	GSFC CS Engineer	2.17			1.21	0.96		
DGLCT	GSFC CS Technician	1.40			0.56	0.82	0.03	
TOTAL	64	3.57			1.77	1.78	0.03	
4.1.6.5 MIC	ROMETEOROID SHIELD/THERMA	L BLANKET						
DGLCE	GSFC CS Engineer	0.27		0.10	0.11	0.06		
TOTAL	65	0.27		0.10	0.11	0.06		
4.1.6.6 ACD	MECHANICAL QUALIFICATION	& CALIBRAT	•					
DGLCE	GSFC CS Engineer	0.31			0.04	0.26		
DGLCT	GSFC CS Technician	0.09			0.04	0.05		
TOTAL	66	0.40			0.08	0.32		
4.1.6.7 ACD	INTEGRATION & TEST							
DGLCE	GSFC CS Engineer	6.68			1.13	1.40	4.02	0.13
DGLCL	GSFC CS Technician	1.17			1.10	0.07	1.03	0.13
TOTAL	67	7.84			1.13	1.46	5.06	0.19
·OIAL	√.	7.04				1.45	0.00	0.10



Civil Service FTE's – Details (2)

			FY	FY	FY	FY	FY	FY
ACT ID	DESC	TOTAL	2000	2001	2002	2003	2004	2005
4.1.6.9 MIS	SION INTEGRATION & TEST SI	UPPORT						
DGLCE	GSFC CS Engineer	0.00						0.00
TOTAL	69	0.00						0.00
4.1.6.B GR	OUND SUPPORT FACILITIES &	EQUIPMENT						
DGLCE	GSFC CS Engineer	1.80		0.14	1.15	0.47	0.04	
DGLCT	GSFC CS Technician	0.14			0.12	0.03		
TOTAL	6B	1.94		0.14	1.27	0.50	0.04	
	REPORT TOTAL	35.41	1.34	3.30	10.08	8.84	8.85	2.99



Total Cost + Commitments – Details (1)

ACT ID	DESC	TOTAL	FY 2000	FY 2001	FY 2002	FY 2003	FY 2004	FY 2005
4.1.6.1 ACI	D PROJECT MANAGEMENT/SUBSYSTE	M ENG.						
DGCI	GSFC In PO Commitment	2803194			1047156	652243	765045	338750
DGCO	GSFC Out PO Commitment	-2803194			-559308	-943188	-797633	-503065
DGL\$	GSFC Labor (fully loaded)	227999	77422	150577				
DGLCC	GSFC CS Clerical							
DGLCE	GSFC CS Engineer							
DGLCP DGLCR	GSFC CS Prof Admin GLRD CS R&D Supervisory							
DGLCR	GSFC CS Scientist							
DGLHA	GSFC On-Site Administrative	165932			40814	41956	43304	39858
DGLHC	GSFC On-Site Clerical	61716			18984	19518	20142	3072
DGLHE	GSFC H Engineer	339520			109656	112715	87249	29900
DGLHJ	GSFC H Jr Engineer	185994			49582	98346	38067	
DGLUS	GSFC U Sr. Scientist	613060			146682	150773	155615	159990
DGO	GSFC M&S (fully loaded) no travel	125504	7131	13869	21501	23001	45001	15001
DGT	GSFC Travel (fully loaded)	56902			20000	20000	16901	
DGX	GSFC MPS & Lab Tax	3051195	43000	100001	664307	943189	797634	503066
TOTAL	61	4827823	127553	264447	1559375	1118552	1171325	586571
4.1.6.2 SAF	ETY & MISSION ASSURANCE							
DGL\$	GSFC Labor (fully loaded)	76000	25807	50192				
DGLEQ	GSFC Quality Assurance	500428	2000.	00.02	164009	179574	156845	
TOTAL	62	576428	25807	50192	164009	179574	156845	
4.1.6.3 TILI	E SHELL ASSEMBLY (TSA)							
DGCI	GSFC In PO Commitment	421500			61500	360000		
DGCO	GSFC Out PO Commitment	-421500			01000	-421500		
DGL\$	GSFC Labor (fully loaded)	333000	113077	219922		421000		
DGLCE	GSFC CS Engineer	00000						
DGLCP	GSFC CS Prof Admin							
DGLCT	GSFC CS Technician							
DGLEI	GSFC I&T Engineer	15074			11521	3553		
DGLEQ	GSFC Quality Assurance	10965			3887	7079		
DGLHA	GSFC On-Site Administrative	4407			3030	1377		
DGLHE	GSFC H Engineer	154945		77	152130	2738		



Total Cost + Commitments – Details (2)

ACT ID	DESC	TOTAL	FY 2000	FY 2001	FY 2002	FY 2003	FY 2004	FY 2005
4.1.6.3 TILE	SHELL ASSEMBLY (TSA)							
DGLHJ	GSFC H Jr Engineer	18690		25	15082	3583		
DGLHT	GSFC H Sr Technician	41752			26639	15113		
DGO	GSFC M&S (fully loaded) no travel	1022724	7470	16072	182998	808183	8001	
DGT	GSFC Travel (fully loaded)	19001			5001	8000	6001	
TOTAL	63	1620559	120548	236096	461788	788126	14001	
4.1.6.4 BAS	E ELECTRONICS ASSEMBLY (BEA)							
DGCI	GSFC In PO Commitment	785400			430850	354550		
DGCO	GSFC Out PO Commitment	-785400			-156075	-589325	-40000	
DGL\$	GSFC Labor (fully loaded)	420000	142620	277380				
DGLCE	GSFC CS Engineer							
DGLCT	GSFC CS Technician							
DGLEQ	GSFC Quality Assurance	17509			377	14739	2392	
DGLHE	GSFC H Engineer	241675			206623	35052		
DGLHJ	GSFC H Jr Engineer	6596			6198	398	4==00	
DGLHT	GSFC H Sr Technician	194215	00447	50050	24769	123657	45788	
DGO DGT	GSFC M&S (fully loaded) no travel GSFC Travel (fully loaded)	898520 6481	26147	50853	188039 1400	592360 4115	41120 966	
TOTAL	64	1784995	168768	328233	702181	535546	50267	
			100700	020200	702101	000040	30201	
4.1.6.5 MICI	ROMETEOROID SHIELD/THERMAL BLA	NKEI						
DGCI	GSFC In PO Commitment	50000			50000			
DGCO	GSFC Out PO Commitment	-50000			-50000			
DGLCE	GSFC CS Engineer							
DGLEQ	GSFC Quality Assurance	194				194		
DGLHA	GSFC On-Site Administrative	2314			995	1319		
DGLHE	GSFC H Engineer	12069			1674	10395		
DGLHJ DGO	GSFC H Jr Engineer	14468			1627	12841		
	GSFC M&S (fully loaded) no travel	121051			107567	13483		
TOTAL	00	150096			111863	38233		



Total Cost + Commitments – Details (3)

ACT ID	DESC	TOTAL	FY 2000	FY 2001	FY 2002	FY 2003	FY 2004	FY 2005
4.1.6.6 ACE	MECHANICAL QUALIFICATION & CAL	IBRAT						
DGLCE	GSFC CS Engineer							
DGLCT	GSFC CS Technician							
DGLEI	GSFC l&T Engineer	4345			3473	871		
DGLEQ	GSFC Quality Assurance	1745			0404	1745		
DGLHE	GSFC H Engineer	37789			3134	34656		
DGL HJ DGO	GSFC H Jr Engineer	50363 102183			10869 5494	39495 96690		
DGO	GSFC M&S (fully loaded) no travel GSFC Travel (fully loaded)	6008			2101	3907		
TOTAL	66	202434			25071	177364		
IOIAL	00	202434			2307 1	177304		
4.1.6.7 ACE	INTEGRATION & TEST							
DGLCE	GSFC CS Engineer							
DGLCT	GSFC CS Technician							
DGLHE	GSFC H Engineer	190657				4810	177717	8130
DGLHJ	GSFC H Jr Engineer	107439					100345	7094
DGLHT	GSFC H Sr Technician	122877				5105	111918	5854
DGO	GSFC M&S (fully loaded) no travel	182005					182005	
DGT	GSFC Travel (fully loaded)	25000					25000	
TOTAL	67	627978				9915	596986	21078
4.1.6.8 LAT	INTEGRATION & TEST SUPPORT							
DGT	GSFC Travel (fully loaded)	35630						35630
TOTAL	68	35630						35630



Total Cost + Commitments – Details (4)

ACT ID	DESC	TOTAL	FY 2000	FY 2001	FY 2002	FY 2003	FY 2004	FY 2005
4.1.6.9 MIS	SION INTEGRATION & TEST SUPPORT							
DGLCE DGLHE DGO TOTAL	GSFC CS Engineer GSFC H Engineer GSFC M&S (fully loaded) no travel 69	217 1162 1380						217 1162 1380
4.1.6.B GR	OUND SUPPORT FACILITIES & EQUIPM	ENT						
DGCI DGCO DGLCE DGLCT	GSFC In PO Commitment GSFC Out PO Commitment GSFC CS Engineer GSFC CS Technician	21000 -21000			21000 -21000			
DGLEI DGLEQ	GSFC l&T Engineer GSFC Quality Assurance	13487 1169				12879 970	609 199	
4.1.6.B GR	DUND SUPPORT FACILITIES & EQUIPM	ENT						
DGLHA DGLHE DGLHJ DGLHT DGO TOTAL	GSFC On-Site Administrative GSFC H Engineer GSFC H Jr Engineer GSFC H Sr Technician GSFC M&S (fully loaded) no travel 6B	552 104317 23944 80620 229005 453094		32 32	552 65271 465 30760 96060 193109	34558 16623 49859 129313 244202	4456 6856 3631 15752	
	REPORT TOTAL	10280416	442676	879000	3217395	3091511	2005176	644658



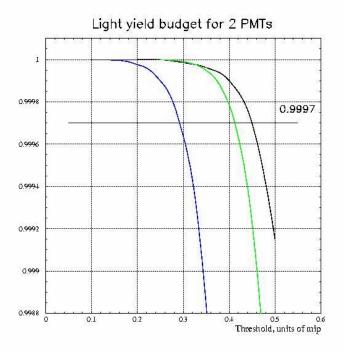
ACD Technical Heritage

- Plastic Scintillator used in all previous gamma-ray telescopes OSO-3, SAS-2, COS-B, CGRO (all 4 instruments), plus many cosmic ray experiments.
- Waveshifting fibers used in GLAST LAT Balloon Flight Engineering Model (BFEM). Waveshifting bars used by HEXTE on RXTE (same material in a different geometry)
- Photomultiplier tubes used in all previous gamma-ray telescopes.
 HEXTE/RXTE used a commercial version of the same tube we are
 using (Hamamatsu 4443), and GOLF on SOHO used the same tube as
 the ACD except for the cathode material (Hamamatsu 4444)
- High Voltage Bias Supplies used in all previous gamma-ray telescopes, plus many cosmic ray experiments.
- Electronics similar ASIC's (same designer) used on the BFEM.
 Discriminators, PHA and logic signals similar to many flight instruments.
- Micrometeoroid Shield Improved version (more layers, stronger materials) of shield that protected EGRET successfully for nine years.



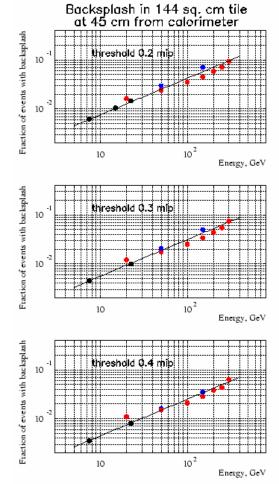
Meeting the Level III Key Requirements

Detection Efficiency 0.9997



Black line: measured efficiency Green line: efficiency with 15% loss Blue line: efficiency with 40% loss

Backsplash Loss <20% at 300 GeV



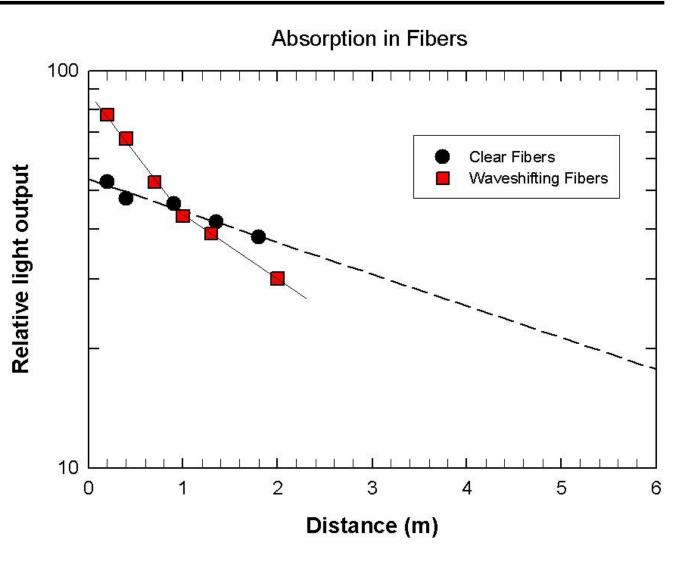
Measurements at SLAC and CERN



Light Absorption in Fibers – an Issue

Absorption in the waveshifting fibers is substantial.

Absorption in the clear fibers is not negligible, and appears higher than advertised by the vendor.





Flowdown - Requirements to Design

Parameter	Requirement	Constraints	Characteristics Needed	Design
Detection of Charged	≥ 0.9997 average detection efficiency	Mass	High-sensitivity charged particle	Plastic scintillator tiles, 1 cm thick, < 1000 cm ²
Particles	over entire area of ACD (less for bottom row of	Power	detector	size
	tiles)	Size	No gaps	Waveshifting fiber light collection, with clear
		Lifetime	Low energy threshold for high efficiency	fibers for transmission in long runs
		Low backsplash sensitivity	Performance margin to compensate for aging	Overlap one dimension, seal other with scintillating fiber ribbons
		Minimize inert material outside active detector		
False VETO rate -	< 20% false VETO's due to calorimeter	Mass	Detector with low sensitivity to soft	Photomultiplier tubes, with gain set low at start of mission
backsplash	backsplash at 300 GeV	Power	photons	
		Size	Segmentation < 1000 cm ²	Low-noise electronics
		Lifetime	High energy threshold (backsplash is soft)	Threshold well below MIP peak but above most of backsplash
	•	High charged particle detection efficiency		



ACD Optimization - Summary

- Light Collection optimized with 5 mm fiber spacing, TETRATEC wrapping material, aluminized fiber ends, multiclad fibers. Scintillator manufacturer does not matter. Two sets of interleaved fibers for redundant readout.
- Absolute Efficiency using the light collection described above, a single phototube meets the 0.9997 efficiency requirement at 0.3 MIP threshold if there are no appreciable light losses. With two tubes operating, there is ample margin. Light losses in long waveshifting fibers or connector to clear fibers makes the single tube marginal.
- Broken Fibers the ACD could meet its requirements with up to two broken fibers on up to three tiles.
- Segmentation the 89-tile design meets the backsplash requirements.
- Hermeticity a double layer of square 1.5 mm fibers with offset centers provides adequate sealing of the gaps between tiles.
- REFERENCE: LAT-TD-00438-D2

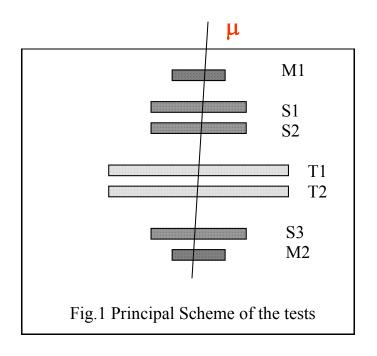


End-to-end efficiency and light yield measurement

Tested detectors:

- Sample 1. 32cm by 32 cm tile with two (short) bundles of WSF fibers flight prototype
- Sample 2. similar tile, but with fiberto-fiber optical connector and 115 cm long clear fiber bundles
- Sample 3. similar tile, but with thermally spliced 65 cm long clear fibers

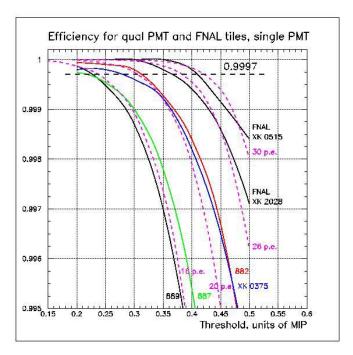
Tests were performed with cosmic muons according to the scheme shown in Fig.1 (M1, M2, S1, S2, S3 - triggering detectors, T1 and T2 - tiles being tested)

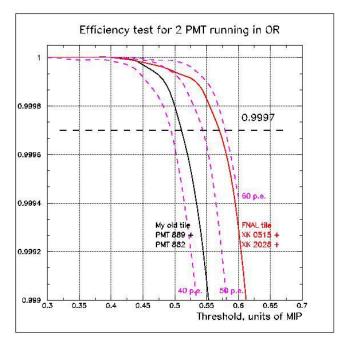




End-to-end efficiency and light yield measurement (cont.)

Results for sample 1





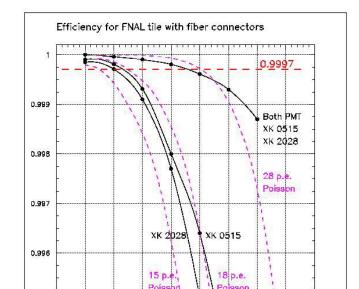
Single PMT running; black lines show measured efficiency for each of 2 PMTs

Both PMTs running in "OR". Red line shows measured efficiency for sample 1



Perform end-to-end efficiency and light yield measurement (cont.)

Results for sample 2



For more details see notes "Design qualification tests for ACD TDA", A.Moiseev, 05/28/02

0.2 0.25 0.3

Name Document: LAT-PR-#####-##

Threshold, units of MIP

• Tests with sample 3 (thermally spliced fibers) demonstrated similar performance as sample 2

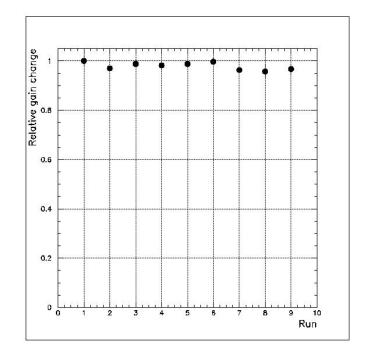
Conclusion.

- 1. Tile performance depends on the Q.E. of the phototube; we will have all tubes with the minimum Q.E. lying between that which were used here (XK 2082 and XK 0515). We can expect efficiency of around 0.999 for single PMT and nominal threshold.
- 2. We see significant light loss in sample 2 with respect to sample 1 (around 50%). We have an indication that about half of it is lost in the connector, and another half in clear fibers
- 3. Currently we are repeating these tests for more confidence



Perform thermal cycling for the tile

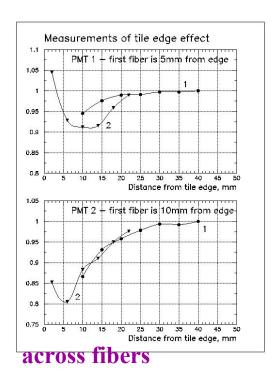
- Thermal cycling was performed from -65C to +45C.
- There were 8 sets of cycles. The test tile and a reference tile were tested after each set.
- The tested parameter was the response to single MIP (cosmic muons) looking for decrease of the tile light yield which would be revealed by the shift of the MIP peak position
- The results are shown in a figure, there the last point (9) corresponds to 340 thermal cycles in total
- We see that the tile degradation is under 5%

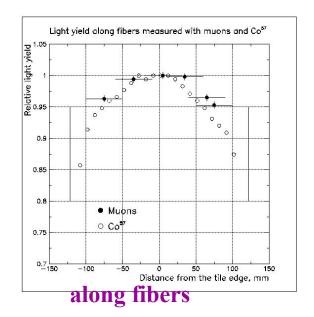




Light yield dependence along fibers in TDA

- Light yield uniformity for TDA was measured by using cosmic muons and fiber hodoscope
- For the measurements across the fibers the collimated radioactive source was also used







Fiber ribbon design

- The design is complete (two layers of fibers with eight 1.5 mm square fibers in the first and 9 the same fibers - in the second)
- The prototype fiber ribbon made at Washington U. was tested and bent to the shape
- The fixture for the bending of flight ribbons is being designed and built
- 7 more sets of ribbons are made at Washington U
- The first flight prototype ribbon will be bent in mid-August

